

## 150mA, 100V High Speed Switching Diode

### FEATURES

- AEC-Q101 qualified
- Fast switching speed
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

### APPLICATIONS

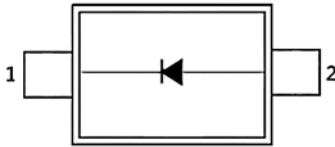
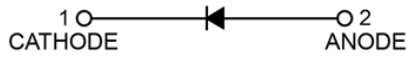
- High-speed switching
- General-purpose switching

### MECHANICAL DATA

- Case: SOD-523F
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 1.60mg (approximately)

| KEY PARAMETERS       |            |      |
|----------------------|------------|------|
| PARAMETER            | VALUE      | UNIT |
| $I_F$                | 150        | mA   |
| $V_{RRM}$            | 100        | V    |
| $I_{FSM}$            | 2          | A    |
| $T_{J\ MAX}$         | 150        | °C   |
| $V_F$ at $I_F=150mA$ | 1.25       | V    |
| Configuration        | Single die |      |



| PACKAGE: SOD-523F                                                                   | PIN CONFIGURATION                                                                   | CIRCUIT DIAGRAM                                                                       |
|-------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|
|  |  |  |

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

| PARAMETER                                 |              | SYMBOL    | VALUE       | UNIT |
|-------------------------------------------|--------------|-----------|-------------|------|
| Power dissipation <sup>(1)</sup>          |              | $P_D$     | 200         | mW   |
| Repetitive peak reverse voltage           |              | $V_{RRM}$ | 100         | V    |
| Average rectified output current          |              | $I_O$     | 150         | mA   |
| Forward continuous current                |              | $I_{FM}$  | 300         | mA   |
| Non-repetitive peak forward surge current | $t = 1s$     | $I_{FSM}$ | 1           | A    |
|                                           | $t = 1\mu s$ |           | 2           | A    |
| Junction temperature                      |              | $T_J$     | -55 to +150 | °C   |
| Storage temperature                       |              | $T_{STG}$ | -55 to +150 | °C   |

#### Note:

1. Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint

**THERMAL PERFORMANCE**

| PARAMETER                                             | SYMBOL          | TYP | UNIT |
|-------------------------------------------------------|-----------------|-----|------|
| Junction-to-ambient thermal resistance <sup>(1)</sup> | $R_{\theta JA}$ | 625 | °C/W |

**Thermal Performance Note:**

1. Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint

**ELECTRICAL SPECIFICATIONS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

| PARAMETER                      | CONDITIONS                                                           | SYMBOL   | MIN | TYP | MAX   | UNIT          |
|--------------------------------|----------------------------------------------------------------------|----------|-----|-----|-------|---------------|
| Forward voltage <sup>(1)</sup> | $I_F = 1\text{mA}$                                                   | $V_F$    | -   | -   | 0.715 | V             |
|                                | $I_F = 10\text{mA}$                                                  |          | -   | -   | 0.855 |               |
|                                | $I_F = 50\text{mA}$                                                  |          | -   | -   | 1.000 |               |
|                                | $I_F = 150\text{mA}$                                                 |          | -   | -   | 1.250 |               |
| Reverse breakdown voltage      | $I_R = 100\mu\text{A}$                                               | $V_{BR}$ | 100 | -   | -     | V             |
| Reverse current <sup>(2)</sup> | $V_R = 75\text{V}$                                                   | $I_R$    | -   | -   | 0.5   | $\mu\text{A}$ |
|                                | $V_R = 75\text{V}, T_J = 150^\circ\text{C}$                          |          | -   | -   | 50    | $\mu\text{A}$ |
| Junction capacitance           | $f = 1\text{MHz}, V_R = 0\text{V}$                                   | $C_J$    | -   | -   | 2     | pF            |
| Reverse recovery time          | $I_F = I_R = 10\text{mA},$<br>$I_{RR} = 1\text{mA}, R_L = 100\Omega$ | $t_{rr}$ | -   | -   | 4     | ns            |

**Notes:**

1. Pulse test with  $PW = 0.3\text{ ms}$
2. Pulse test with  $PW = 30\text{ ms}$

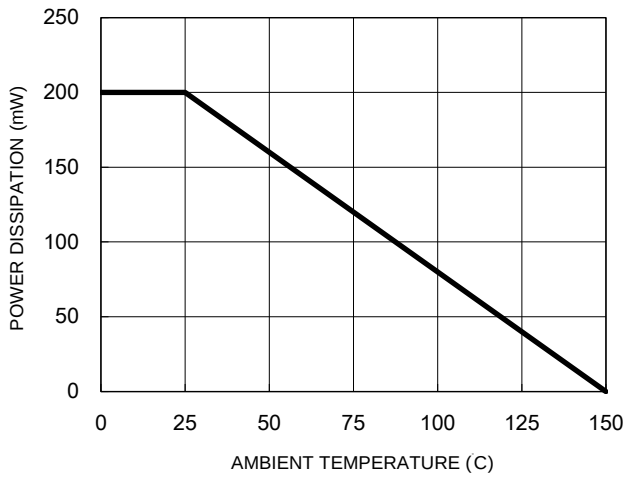
**ORDERING INFORMATION**

| ORDERING CODE | PACKAGE  | PACKING                |
|---------------|----------|------------------------|
| 1N4148WTH RSG | SOD-523F | 8,000 / 7" Tape & Reel |

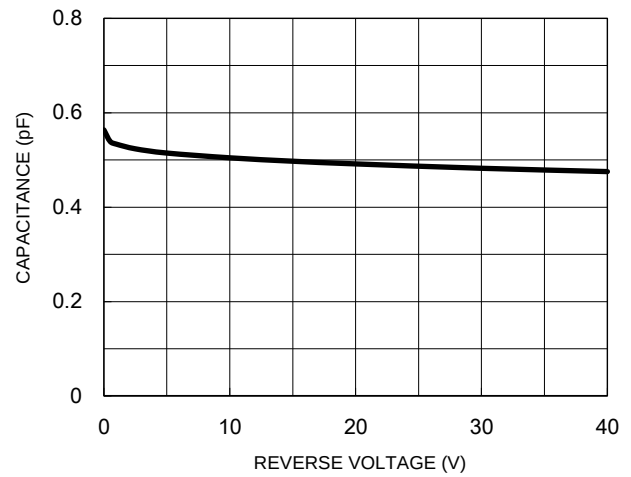
## CHARACTERISTICS CURVES

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

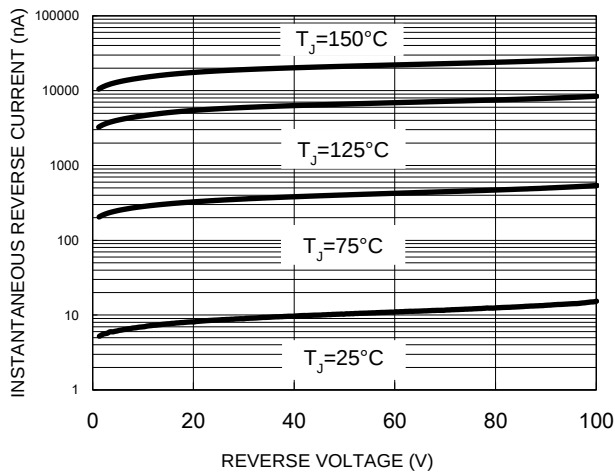
**Fig.1 Power Dissipation Curve**



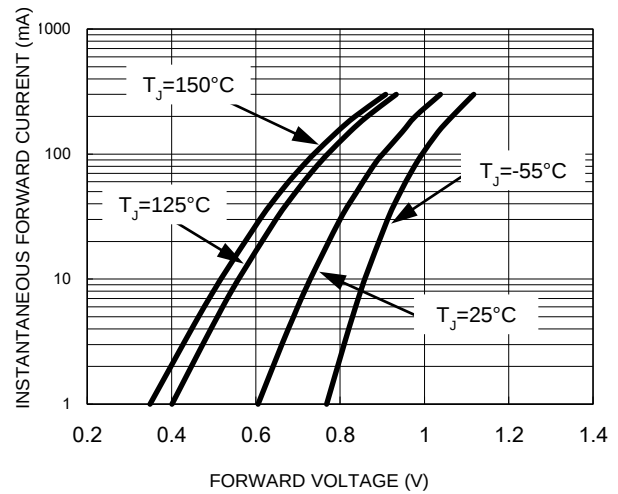
**Fig.2 Typical Junction Capacitance**



**Fig.3 Typical Reverse Characteristics**

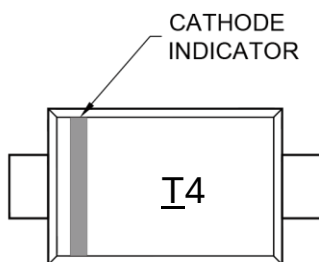
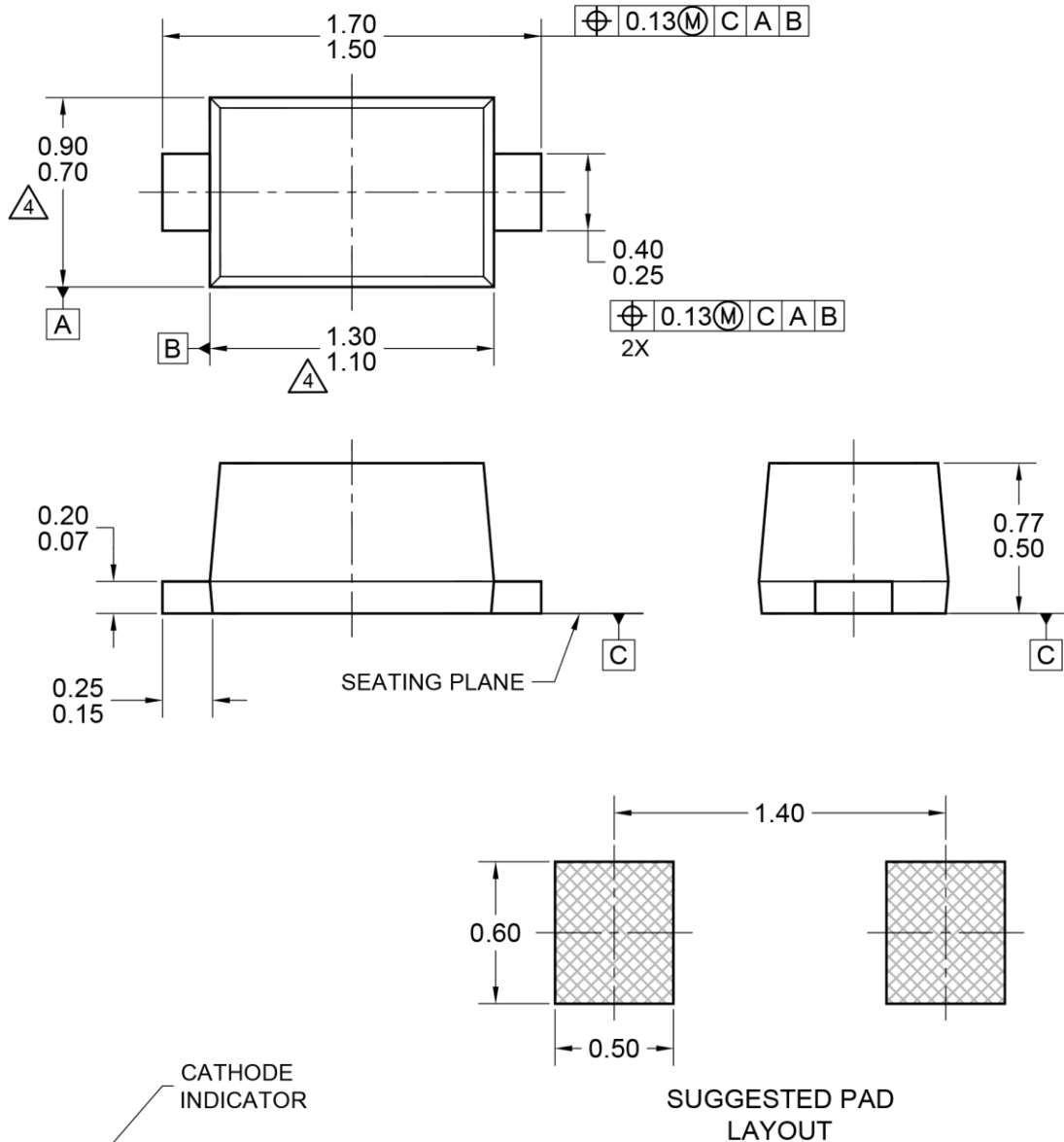


**Fig.4 Typical Forward Characteristics**



## PACKAGE OUTLINE DIMENSION

### SOD-523F



MARKING DIAGRAM

**I4** = Device marking

#### NOTES: UNLESS OTHERWISE SPECIFIED

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
3. PACKAGE OUTLINE REFERENCE:  
EIAJ ED-7500A, SC-79.
4. MOLDED PLASTIC BODY LATERAL DIMENSIONS DO NOT INCLUDE MOLD FLASH.
5. DWG NO. REF: HQ2SD07-SOD523F-047 REV A.

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